

Command Table											Command	Description
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0		
0	0	26	0	0	1	0	0	1	1	0	Write RAM (RED) / RAM 0x26	<p>After this command, data entries will be written into the RED RAM until another command is written. Address pointers will advance accordingly.</p> <p>For Red pixel: Content of Write RAM(RED) = 1 For non-Red pixel [Black or White]: Content of Write RAM(RED) = 0</p>
0	0	27	0	0	1	0	0	1	1	1	Read RAM	<p>After this command, data read on the MCU bus will fetch data from RAM. According to parameter of Register 41h to select reading RAM0x24/ RAM0x26, until another command is written. Address pointers will advance accordingly.</p> <p>The 1st byte of data read is dummy data.</p>
0	0	28	0	0	1	0	1	0	0	0	VCOM Sense	<p>Enter VCOM sensing conditions and hold for duration defined in 29h before reading VCOM value. The sensed VCOM voltage is stored in register The command required CLKEN=1 and ANALOGEN=1 Refer to Register 0x22 for detail.</p> <p>BUSY pad will output high during operation.</p>
0	0	29	0	0	1	0	1	0	0	1	VCOM Sense Duration	<p>Stabling time between entering VCOM sensing mode and reading acquired.</p> <p>A[3:0] = 9h, duration = 10s. VCOM sense duration = (A[3:0]+1) sec</p>
0	1		0	1	0	0	A ₃	A ₂	A ₁	A ₀		
0	0	2A	0	0	1	0	1	0	1	0	Program VCOM OTP	<p>Program VCOM register into OTP</p> <p>The command required CLKEN=1. Refer to Register 0x22 for detail.</p> <p>BUSY pad will output high during operation.</p>

Command Table																
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description				
0	0	2C	0	0	1	0	1	1	0	0	Write VCOM register	Write VCOM register from MCU interface A[7:0] = 00h [POR]				
0	1		A7	A6	A5	A4	A3	A2	A1	A0						
													A[7:0]	VCOM	A[7:0]	VCOM
													08h	-0.2	44h	-1.7
													0Ch	-0.3	48h	-1.8
													10h	-0.4	4Ch	-1.9
													14h	-0.5	50h	-2
													18h	-0.6	54h	-2.1
													1Ch	-0.7	58h	-2.2
													20h	-0.8	5Ch	-2.3
													24h	-0.9	60h	-2.4
													28h	-1	64h	-2.5
													2Ch	-1.1	68h	-2.6
													30h	-1.2	6Ch	-2.7
													34h	-1.3	70h	-2.8
													38h	-1.4	74h	-2.9
											3Ch	-1.5	78h	-3		
											40h	-1.6	Other	NA		
0	0	2D	0	0	1	0	1	1	0	1	OTP Register Read for Display Option	Read Register for Display Option: A[7:0]: VCOM OTP Selection (Command 0x37, Byte A) B[7:0]: VCOM Register (Command 0x2C) C[7:0]~G[7:0]: Display Mode (Command 0x37, Byte B to Byte F) [5 bytes] H[7:0]~K[7:0]: Waveform Version (Command 0x37, Byte G to Byte J) [4 bytes]				
1	1		A7	A6	A5	A4	A3	A2	A1	A0						
1	1		B7	B6	B5	B4	B3	B2	B1	B0						
1	1		C7	C6	C5	C4	C3	C2	C1	C0						
1	1		D7	D6	D5	D4	D3	D2	D1	D0						
1	1		E7	E6	E5	E4	E3	E2	E1	E0						
1	1		F7	F6	F5	F4	F3	F2	F1	F0						
1	1		G7	G6	G5	G4	G3	G2	G1	G0						
1	1		H7	H6	H5	H4	H3	H2	H1	H0						
1	1		I7	I6	I5	I4	I3	I2	I1	I0						
1	1		J7	J6	J5	J4	J3	J2	J1	J0						
1	1		K7	K6	K5	K4	K3	K2	K1	K0						
0	0	2E	0	0	1	0	1	1	1	0	User ID Read	Read 10 Byte User ID stored in OTP: A[7:0]~J[7:0]: UserID (R38, Byte A and Byte J) [10 bytes]				
1	1		A7	A6	A5	A4	A3	A2	A1	A0						
1	1		B7	B6	B5	B4	B3	B2	B1	B0						
1	1		C7	C6	C5	C4	C3	C2	C1	C0						
1	1		D7	D6	D5	D4	D3	D2	D1	D0						
1	1		E7	E6	E5	E4	E3	E2	E1	E0						
1	1		F7	F6	F5	F4	F3	F2	F1	F0						
1	1		G7	G6	G5	G4	G3	G2	G1	G0						
1	1		H7	H6	H5	H4	H3	H2	H1	H0						
1	1		I7	I6	I5	I4	I3	I2	I1	I0						
1	1		J7	J6	J5	J4	J3	J2	J1	J0						

Command Table											Command	Description
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0		
0	0	2F	0	0	1	0	1	1	1	1	Status Bit Read	Read IC status Bit [POR 0x01] A[5]: HV Ready Detection flag [POR=0] 0: Ready 1: Not Ready A[4]: VCI Detection flag [POR=0] 0: Normal 1: VCI lower than the Detect level A[3]: [POR=0] A[2]: Busy flag [POR=0] 0: Normal 1: BUSY A[1:0]: Chip ID [POR=01] Remark: A[5] and A[4] status are not valid after RESET, they need to be initiated by command 0x14 and command 0x15 respectively.
1	1		0	0	A ₅	A ₄	0	0	A ₁	A ₀		
0	0	30	0	0	1	1	0	0	0	0	Program WS OTP	Program OTP of Waveform Setting The contents should be written into RAM before sending this command. The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation.
0	0	31	0	0	1	1	0	0	0	1	Load WS OTP	Load OTP of Waveform Setting The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation.
0	0	32	0	0	1	1	0	0	1	0	Write LUT register	Write LUT register from MCU interface [227 bytes], which contains the content of VS[nX-LUTm], TP[nX], RP[n], SR[nXY], FR and XON[nXY] Refer to Session 6.7 WAVEFORM SETTING
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		
0	1		:	:	:	:	:	:	:	:		
0	1			
0	0	34	0	0	1	1	0	1	0	0	CRC calculation	CRC calculation command For details, please refer to SSD1680A application note. BUSY pad will output high during operation.
0	0	35	0	0	1	1	0	1	0	1	CRC Status Read	CRC Status Read A[15:0] is the CRC read out value
1	1		A ₁₅	A ₁₄	A ₁₃	A ₁₂	A ₁₁	A ₁₀	A ₉	A ₈		
1	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		

Command Table											Command	Description
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0		
0	0	36	0	0	1	1	0	1	1	0	Program OTP selection	Program OTP Selection according to the OTP Selection Control [R37h and R38h] The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation.
0	0	37	0	0	1	1	0	1	1	1	Write Register for Display Option	Write Register for Display Option A[7] Spare VCOM OTP selection 0: Default [POR] 1: Spare B[7:0] Display Mode for WS[7:0] C[7:0] Display Mode for WS[15:8] D[7:0] Display Mode for WS[23:16] 0: Display Mode 1 1: Display Mode 2 F[6]: Ping-Pong for Display Mode 2 0: RAM Ping-Pong disable [POR] 1: RAM Ping-Pong enable G[7:0]~J[7:0] module ID /waveform version. Remarks: 1) A[7:0]~J[7:0] can be stored in OTP 2) RAM Ping-Pong function is not support for Display Mode 1
0	1		A ₇	0	0	0	0	0	0	0		
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		
0	1		C ₇	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀		
0	1		D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀		
0	1		E ₇	E ₆	E ₅	E ₄	E ₃	E ₂	E ₁	E ₀		
0	1		0	F ₆	0	0	F ₃	F ₂	F ₁	F ₀		
0	1		G ₇	G ₆	G ₅	G ₄	G ₃	G ₂	G ₁	G ₀		
0	1		H ₇	H ₆	H ₅	H ₄	H ₃	H ₂	H ₁	H ₀		
0	1		I ₇	I ₆	I ₅	I ₄	I ₃	I ₂	I ₁	I ₀		
0	1		J ₇	J ₆	J ₅	J ₄	J ₃	J ₂	J ₁	J ₀		
0	0	38	0	0	1	1	1	0	0	0	Write Register for User ID	Write Register for User ID A[7:0]~J[7:0]: UserID [10 bytes] Remarks: A[7:0]~J[7:0] can be stored in OTP
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		
0	1		C ₇	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀		
0	1		D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀		
0	1		E ₇	E ₆	E ₅	E ₄	E ₃	E ₂	E ₁	E ₀		
0	1		F ₇	F ₆	F ₅	F ₄	F ₃	F ₂	F ₁	F ₀		
0	1		G ₇	G ₆	G ₅	G ₄	G ₃	G ₂	G ₁	G ₀		
0	1		H ₇	H ₆	H ₅	H ₄	H ₃	H ₂	H ₁	H ₀		
0	1		I ₇	I ₆	I ₅	I ₄	I ₃	I ₂	I ₁	I ₀		
0	1		J ₇	J ₆	J ₅	J ₄	J ₃	J ₂	J ₁	J ₀		
0	0	39	0	0	1	1	1	0	0	1	OTP program mode	OTP program mode A[1:0] = 00: Normal Mode [POR] A[1:0] = 11: Internal generated OTP programming voltage : User is required to EXACTLY follow the reference code sequences
0	1		0	0	0	0	0	0	A ₁	A ₀		

Command Table											Command	Description	
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0			
0	0	3C	0	0	1	1	1	1	0	0	Border Waveform Control	Select border waveform for VBD	
0	1		A ₇	A ₆	A ₅	A ₄	0	0	A ₁	A ₀		A[7:0] = C0h [POR], set VBD as HiZ. A [7:6] :Select VBD option	
												A[7:6]	Select VBD as
												00	GS Transition, Defined in A[2] and A[1:0]
												01	Fix Level, Defined in A[5:4]
												10	VCOM
												11[POR]	HiZ
												A [5:4] Fix Level Setting for VBD	
												A[5:4]	VBD level
												00	VSS
												01	VSH1
												10	VSL
												11	VSH2
												A [1:0] GS Transition setting for VBD VBD Level Selection: 00b: VCOM ; 01b: VSH1; 10b: VSL; 11b: VSH2	
												A[1:0]	VBD Transition
											00	LUT0	
											01	LUT1	
											10	LUT2	
											11	LUT3	
0	0	3F	0	0	1	1	1	1	1	1	End Option (EOPT)	Option for LUT end	
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		Data bytes should be set for this command or programmed into Waveform setting.	
												22h	Normal.
												07h	Source output level keep previous output before power off
0	0	41	0	1	0	0	0	0	0	1	Read RAM Option	Read RAM Option	
0	1		0	0	0	0	0	0	0	A ₀		A[0]= 0 [POR] 0 : Read RAM corresponding to RAM0x24 1 : Read RAM corresponding to RAM0x26	
0	0	44	0	1	0	0	0	1	0	0	Set RAM X - address Start / End position	Specify the start/end positions of the window address in the X direction by an address unit for RAM	
0	1		0	0	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		A[5:0]: XSA[5:0], XStart, POR = 00h B[5:0]: XEA[5:0], XEnd, POR = 15h	
0	1		0	0	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀			
0	0	45	0	1	0	0	0	1	0	1	Set Ram Y- address Start / End position	Specify the start/end positions of the window address in the Y direction by an address unit for RAM	
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀			
0	1		0	0	0	0	0	0	0	A ₈			
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		A[8:0]: YSA[8:0], YStart, POR = 000h B[8:0]: YEA[8:0], YEnd, POR = 127h	
0	1		0	0	0	0	0	0	0	B ₈			

Command Table											Command	Description																																								
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0																																										
0	0	46	0	1	0	0	0	1		0	Auto Write RED RAM for Regular Pattern	Auto Write RED RAM for Regular Pattern A[7:0] = 00h [POR]																																								
0	1		A ₇	A ₆	A ₅	A ₄	0	A ₂	A ₁	A ₀		<p>A[7]: The 1st step value, POR = 0 A[6:4]: Step Height, POR= 000 Step of alter RAM in Y-direction according to Gate</p> <table border="1"> <thead> <tr> <th>A[6:4]</th> <th>Height</th> <th>A[6:4]</th> <th>Height</th> </tr> </thead> <tbody> <tr> <td>000</td> <td>8</td> <td>100</td> <td>128</td> </tr> <tr> <td>001</td> <td>16</td> <td>101</td> <td>256</td> </tr> <tr> <td>010</td> <td>32</td> <td>110</td> <td>296</td> </tr> <tr> <td>011</td> <td>64</td> <td>111</td> <td>NA</td> </tr> </tbody> </table> <p>A[2:0]: Step Width, POR= 000 Step of alter RAM in X-direction according to Source</p> <table border="1"> <thead> <tr> <th>A[2:0]</th> <th>Width</th> <th>A[2:0]</th> <th>Width</th> </tr> </thead> <tbody> <tr> <td>000</td> <td>8</td> <td>100</td> <td>128</td> </tr> <tr> <td>001</td> <td>16</td> <td>101</td> <td>176</td> </tr> <tr> <td>010</td> <td>32</td> <td>110</td> <td>NA</td> </tr> <tr> <td>011</td> <td>64</td> <td>111</td> <td>NA</td> </tr> </tbody> </table> <p>BUSY pad will output high during operation.</p>	A[6:4]	Height	A[6:4]	Height	000	8	100	128	001	16	101	256	010	32	110	296	011	64	111	NA	A[2:0]	Width	A[2:0]	Width	000	8	100	128	001	16	101	176	010	32	110	NA	011	64	111	NA
A[6:4]	Height	A[6:4]	Height																																																	
000	8	100	128																																																	
001	16	101	256																																																	
010	32	110	296																																																	
011	64	111	NA																																																	
A[2:0]	Width	A[2:0]	Width																																																	
000	8	100	128																																																	
001	16	101	176																																																	
010	32	110	NA																																																	
011	64	111	NA																																																	
0	0	47	0	1	0	0	0	1	1	1	Auto Write B/W RAM for Regular Pattern	Auto Write B/W RAM for Regular Pattern A[7:0] = 00h [POR]																																								
0	1		A ₇	A ₆	A ₅	A ₄	0	A ₂	A ₁	A ₀		<p>A[7]: The 1st step value, POR = 0 A[6:4]: Step Height, POR= 000 Step of alter RAM in Y-direction according to Gate</p> <table border="1"> <thead> <tr> <th>A[6:4]</th> <th>Height</th> <th>A[6:4]</th> <th>Height</th> </tr> </thead> <tbody> <tr> <td>000</td> <td>8</td> <td>100</td> <td>128</td> </tr> <tr> <td>001</td> <td>16</td> <td>101</td> <td>256</td> </tr> <tr> <td>010</td> <td>32</td> <td>110</td> <td>296</td> </tr> <tr> <td>011</td> <td>64</td> <td>111</td> <td>NA</td> </tr> </tbody> </table> <p>A[2:0]: Step Width, POR= 000 Step of alter RAM in X-direction according to Source</p> <table border="1"> <thead> <tr> <th>A[2:0]</th> <th>Width</th> <th>A[2:0]</th> <th>Width</th> </tr> </thead> <tbody> <tr> <td>000</td> <td>8</td> <td>100</td> <td>128</td> </tr> <tr> <td>001</td> <td>16</td> <td>101</td> <td>176</td> </tr> <tr> <td>010</td> <td>32</td> <td>110</td> <td>NA</td> </tr> <tr> <td>011</td> <td>64</td> <td>111</td> <td>NA</td> </tr> </tbody> </table> <p>During operation, BUSY pad will output high.</p>	A[6:4]	Height	A[6:4]	Height	000	8	100	128	001	16	101	256	010	32	110	296	011	64	111	NA	A[2:0]	Width	A[2:0]	Width	000	8	100	128	001	16	101	176	010	32	110	NA	011	64	111	NA
A[6:4]	Height	A[6:4]	Height																																																	
000	8	100	128																																																	
001	16	101	256																																																	
010	32	110	296																																																	
011	64	111	NA																																																	
A[2:0]	Width	A[2:0]	Width																																																	
000	8	100	128																																																	
001	16	101	176																																																	
010	32	110	NA																																																	
011	64	111	NA																																																	

Command Table												
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	4E	0	1	0	0	1	1	1	0	Set RAM X address counter	Make initial settings for the RAM X address in the address counter (AC) A[5:0]: 00h [POR].
0	1		0	0	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		
0	0	4F	0	1	0	0	1	1	1	1	Set RAM Y address counter	Make initial settings for the RAM Y address in the address counter (AC) A[8:0]: 000h [POR].
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		
0	1		0	0	0	0	0	0	0	A ₈		
0	0	7F	0	1	1	1	1	1	1	1	NOP	This command is an empty command; it does not have any effect on the display module. However it can be used to terminate Frame Memory Write or Read Commands.

8 COMMAND DESCRIPTION

8.1 Driver Output Control (01h)

This triple byte command has multiple configurations and each bit setting is described as follows:

R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1	MUX7	MUX6	MUX5	MUX4	MUX3	MUX2	MUX1	MUX0
POR		0	0	1	1	1	1	1	1
W	1								MUX8
POR									1
W	1						GD	SM	TB
POR							0	0	0

MUX[8:0]: Specify number of lines for the driver: MUX[8:0] + 1. Multiplex ratio (MUX ratio) from 16 MUX to 296MUX.

GD: Selects the 1st output Gate

This bit is made to match the GATE layout connection on the panel. It defines the first scanning line.

SM: Change scanning order of gate driver.

When SM is set to 0, left and right interlaced is performed.

When SM is set to 1, no splitting odd / even of the GATE signal is performed,

Output pin assignment sequence is shown as below (for 296 MUX ratio):

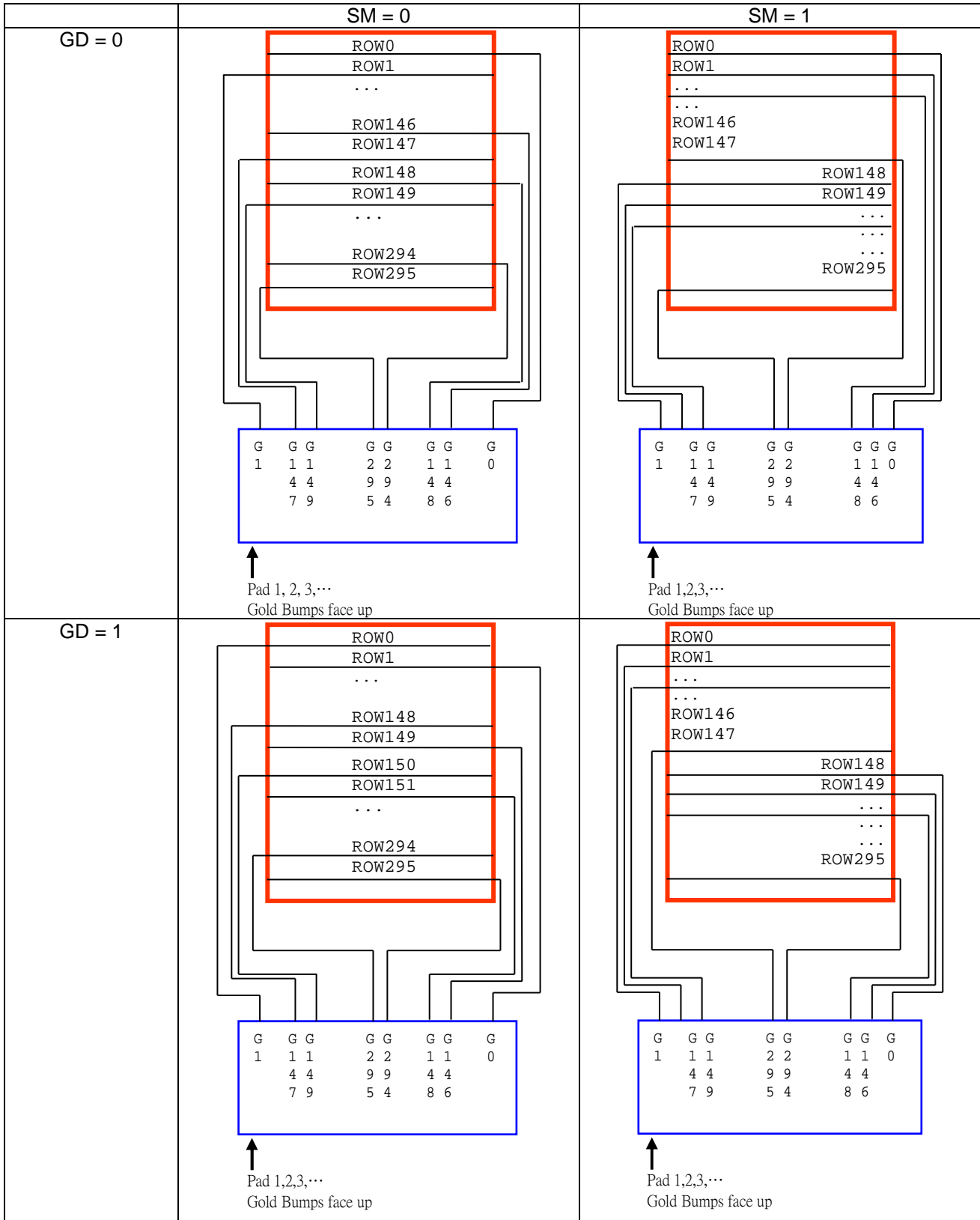
	SM=0	SM=0	SM=1	SM=1
Driver	GD=0	GD=1	GD=0	GD=1
G0	ROW0	ROW1	ROW0	ROW148
G1	ROW1	ROW0	ROW148	ROW0
G2	ROW2	ROW3	ROW1	ROW149
G3	ROW3	ROW2	ROW149	ROW1
:	:	:	:	:
G146	ROW146	ROW147	ROW73	ROW222
G147	ROW147	ROW146	ROW222	ROW73
G148	ROW148	ROW149	ROW74	ROW223
G149	ROW149	ROW148	ROW223	ROW74
:	:	:	:	:
G292	ROW292	ROW293	ROW146	ROW294
G293	ROW293	ROW292	ROW294	ROW146
G294	ROW294	ROW295	ROW147	ROW295
G295	ROW295	ROW294	ROW295	ROW147

See "Scan Mode Setting" on next page.

TB: Change scanning direction of gate driver.

This bit defines the scanning direction of the gate for flexible layout of signals in module either from up to down (TB = 0) or from bottom to up (TB = 1).

Figure 8-1: Output pin assignment on different Scan Mode Setting






8.2 Gate Scan Start Position (0Fh)

R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1	SCN7	SCN6	SCN5	SCN4	SCN3	SCN2	SCN1	SCN0
POR		0	0	0	0	0	0	0	0
W	1	0	0	0	0	0	0	0	SCN8
POR		0	0	0	0	0	0	0	0

This command is to set Gate Start Position for determining the starting gate of display RAM by selecting a value from 0 to 295. Figure 8-2 shows an example using this command when MUX ratio= 295 and MUX ratio= 148. "ROW" means the graphic display data RAM row.

Figure 8-2: Example of Set Display Start Line with no Remapping

GATE Pin	MUX ratio (01h) = 127h	MUX ratio (01h) = 093h	MUX ratio (01h) = 095h
	Gate Start Position (0Fh) = 000h	Gate Start Position (0Fh) = 000h	Gate Start Position (0Fh) = 04Ah
G0	ROW0	ROW0	-
G1	ROW1	ROW1	-
G2	ROW2	ROW2	-
G3	ROW3	ROW3	-
:	:	:	:
G72	:	:	-
G73	:	:	-
G74	:	:	ROW74
G75	:	:	ROW75
:	:	:	:
G146	ROW146	ROW146	:
G147	ROW147	ROW147	:
G148	ROW148	-	:
G149	ROW149	-	:
:	:	:	:
G220	:	:	:
G221	:	:	:
G222	:	:	ROW222
G223	:	:	ROW223
:	:	:	:
G292	ROW292	-	-
G293	ROW293	-	-
G294	ROW294	-	-
G295	ROW295	-	-
Display Example			

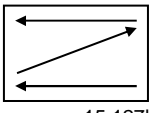
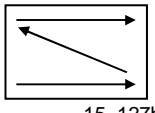
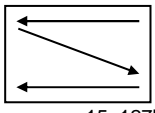
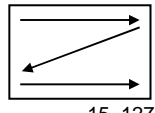
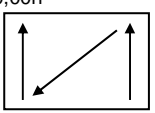
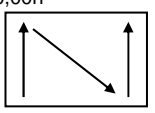
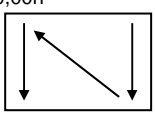
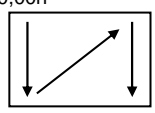
8.3 Data Entry Mode Setting (11h)

This command has multiple configurations and each bit setting is described as follows:

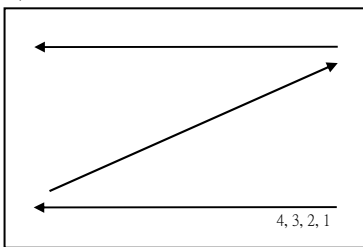
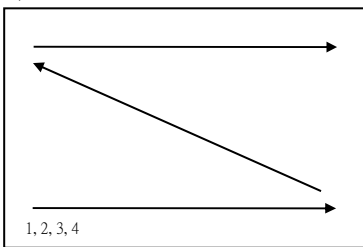
R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1						AM	ID1	ID0
POR		0	0	0	0	0	0	1	1

ID[1:0]: The address counter is automatically incremented by 1, after data is written to the RAM when ID[1:0] = "01". The address counter is automatically decremented by 1, after data is written to the RAM when ID[1:0] = "00". The setting of incrementing or decrementing of the address counter can be made independently in each upper and lower bit of the address. The direction of the address when data is written to the RAM is set by AM bits.

AM: Set the direction in which the address counter is updated automatically after data are written to the RAM. When AM = "0", the address counter is updated in the X direction. When AM = "1", the address counter is updated in the Y direction. When window addresses are selected, data are written to the RAM area specified by the window addresses in the manner specified with ID[1:0] and AM bits.

	ID [1:0]="00" X: decrement Y: decrement	ID [1:0]="01" X: increment Y: decrement	ID [1:0]="10" X: decrement Y: increment	ID [1:0]="11" X: increment Y: increment
AM="0" X-mode	00,00h  15,127h	00,00h  15,127h	00,00h  15,127h	00,00h  15,127h
AM="1" Y-mode	00,00h  15,127h	00,00h  15,127h	00,00h  15,127h	00,00h  15,127h

The pixel sequence is defined by the ID [0],

	ID[1:0]="00" X: decrement Y: decrement	ID[1:0]="01" X: increment Y: decrement
AM="0" X-mode	00,00h  15,127h	00,00h  15,127h

8.4 Set RAM X - Address Start / End Position (44h)

R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1				XSA4	XSA3	XSA2	XSA1	XSA0
POR		0	0	0	0	0	0	0	0
W	1				XEA4	XEA3	XEA2	XEA1	XEA0
POR		0	0	0	1	0	1	0	1

XSA[4:0]/XEA[4:0]: Specify the start/end positions of the window address in the X direction by 8 times address unit. Data is written to the RAM within the area determined by the addresses specified by XSA [4:0] and XEA [4:0]. These addresses must be set before the RAM write.

It allows on $XEA [4:0] \leq XSA [4:0]$. The settings follow the condition on $00h \leq XSA [4:0]$, $XEA [4:0] \leq 15h$. The windows is followed by the control setting of Data Entry Setting (R11h)

8.5 Set RAM Y - Address Start / End Position (45h)

R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1	YSA7	YSA6	YSA5	YSA4	YSA3	YSA2	YSA1	YSA0
POR		0	0	0	0	0	0	0	0
W	1	0	0	0	0	0	0	0	YSA8
POR		0	0	0	0	0	0	0	0
W	1	YEA7	YEA6	YEA5	YEA4	YEA3	YEA2	YEA1	YEA0
POR		0	0	1	0	0	1	1	1
W	1	0	0	0	0	0	0	0	YEA8
POR		0	0	0	0	0	0	0	1

YSA[8:0]/YEA[8:0]: Specify the start/end positions of the window address in the Y direction by an address unit. Data is written to the RAM within the area determined by the addresses specified by YSA [8:0] and YEA [8:0]. These addresses must be set before the RAM write.

It allows $YEA [8:0] \leq YSA [8:0]$. The settings follow the condition on $00h \leq YSA [8:0]$, $YEA [8:0] \leq 127h$. The windows is followed by the control setting of Data Entry Setting (R11h)

8.6 Set RAM Address Counter (4Eh-4Fh)

Reg#	R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
4Eh	W	1				XAD4	XAD3	XAD2	XAD1	XAD0
	POR		0	0	0	0	0	0	0	0
4Fh	W	1	YAD7	YAD6	YAD5	YAD4	YAD3	YAD2	YAD1	YAD0
	POR		0	0	0	0	0	0	0	0
	W	1								YAD8
	POR									

XAD[4:0]: Make initial settings for the RAM X address in the address counter (AC).

YAD[8:0]: Make initial settings for the RAM Y address in the address counter (AC).

After RAM data is written, the address counter is automatically updated according to the settings with AM, ID bits and setting for a new RAM address is not required in the address counter. Therefore, data is written consecutively without setting an address. The address counter is not automatically updated when data is read out from the RAM. RAM address setting cannot be made during the standby mode. The address setting should be made within the area designated with window addresses which is controlled by the Data Entry Setting (R11h) {AM, ID[1:0]} ; RAM Address XStart / XEnd Position (R44h) and RAM Address Ystart /Yend Position (R45h). Otherwise undesirable image will be displayed on the Panel.

9 Operation Flow and Code Sequence

9.1 General operation flow to drive display panel

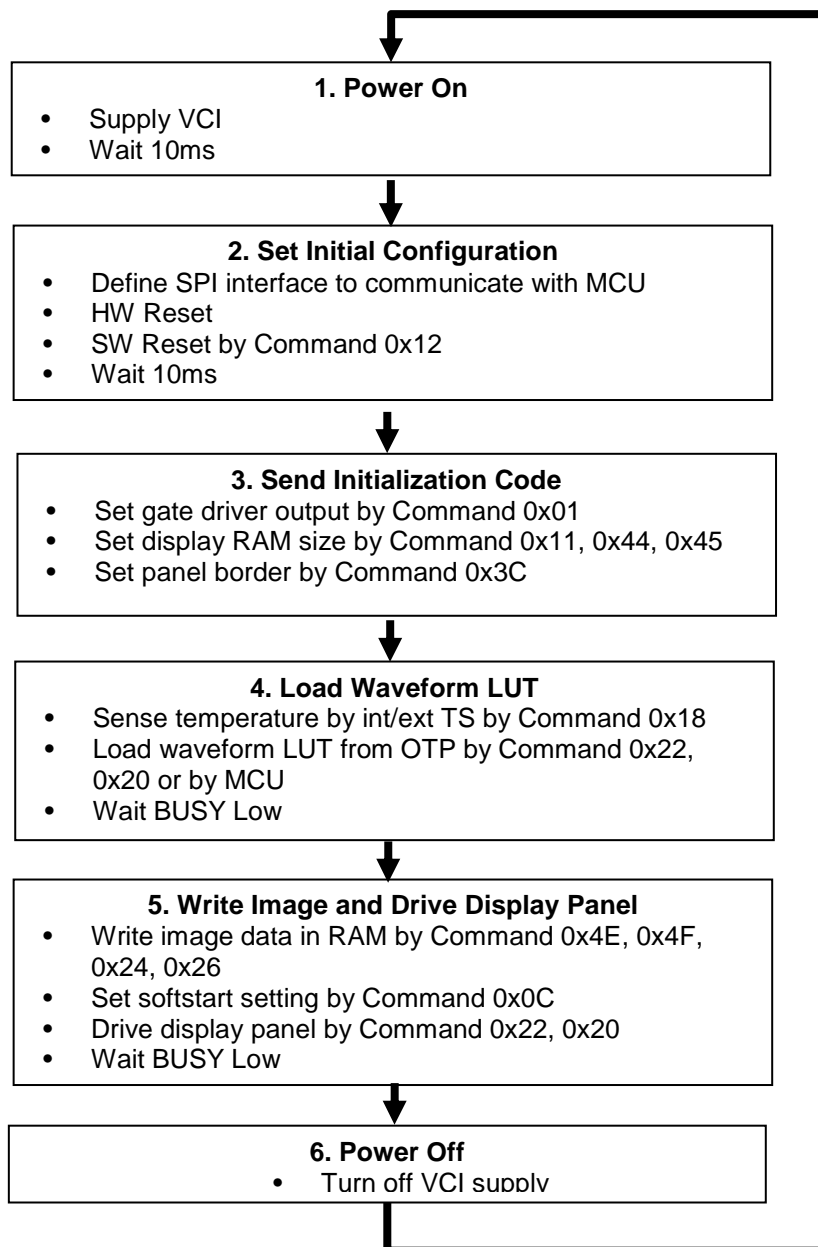


Figure 9-1: Operation flow to drive display panel

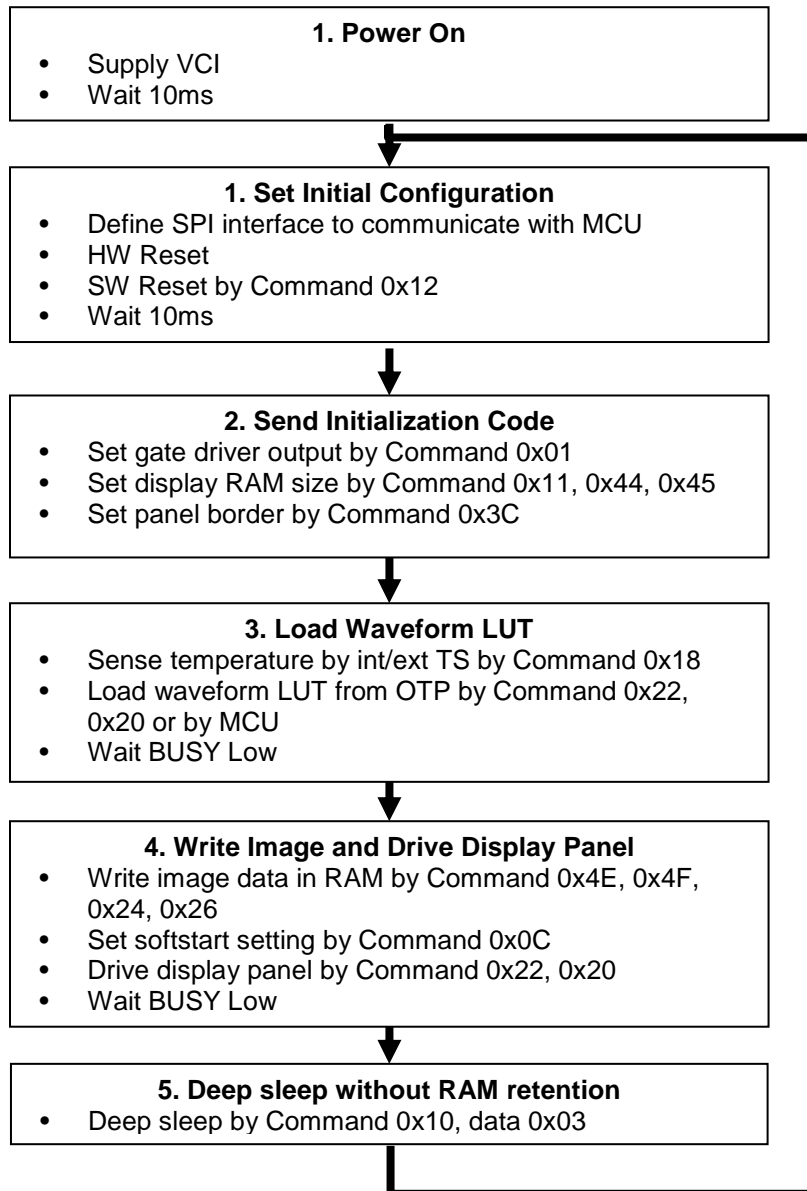


Figure 9-2: Operation flow to drive display panel with deep sleep mode 2

10 Absolute Maximum Rating

Table 10-1 : Maximum Ratings

Symbol	Parameter	Rating	Unit
V _{CI}	Logic supply voltage	-0.5 to +6.0	V
V _{IN}	Logic Input voltage	-0.5 to V _{DDIO} +0.5	V
V _{OUT}	Logic Output voltage	-0.5 to V _{DDIO} +0.5	V
T _{OPR}	Operation temperature range	-40 to +85	°C
T _{STG}	Storage temperature range	-65 to +150	°C

Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description section

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation it is recommended that V_{CI} be constrained to the range V_{SS} < V_{CI}. Reliability of operation is enhanced if unused input is connected to an appropriate logic voltage level (e.g., either V_{SS} or V_{DDIO}). Unused outputs must be left open. This device may be light sensitive. Caution should be taken to avoid exposure of this device to any light source during normal operation. This device is not radiation protected.

11 Electrical Characteristics

The following specifications apply for: V_{SS}=0V, V_{CI}=3.0V, V_DD=1.8V, T_{OPR}=25°C.

Table 11-1: DC Characteristics

Symbol	Parameter	Applicable pin	Test Condition	Min.	Typ.	Max.	Unit
V _{CI}	V _{CI} operation voltage	V _{CI}	-	2.2	3.0	3.7	V
V _D D	V _D D operation voltage	V _D D	-	1.7	1.8	1.9	V
V _{COM_DC}	V _{COM_DC} output voltage	V _{COM}	-	-3.0	-	-0.2	V
dV _{COM_DC}	V _{COM_DC} output voltage deviation	V _{COM}	-	-200	-	200	mV
V _{COM_AC}	V _{COM_AC} output voltage	V _{COM}	-	V _{SL} + V _{COM_DC}	V _{COM_DC}	V _{SH1} + V _{COM_DC}	V
V _{GATE}	Gate output voltage	G0~G295	-	-20	-	+20	V
V _{GATE(p-p)}	Gate output peak to peak voltage	G0~G295	-	-	-	40	V
V _{SH1}	Positive Source output voltage	V _{SH1}	-	+2.4	+15	+17	V
dV _{SH1}	V _{SH1} output voltage deviation	V _{SH1}	From 2.4V to 8.8V	-100	-	100	mV
			From 9.0V to 17V	-200	-	200	mV
V _{SH2}	Positive Source output voltage	V _{SH2}	-	+2.4	+5	+17	V
dV _{SH2}	V _{SH2} output voltage deviation	V _{SH2}	From 2.4V to 8.8V	-100	-	100	mV
			From 9.0V to 17V	-200	-	200	mV
V _{SL}	Negative Source output voltage	V _{SL}	-	-17	-15	-9	V
dV _{SL}	V _{SL} output voltage deviation	V _{SL}	-	-200	-	200	mV
V _{IH}	High level input voltage	SDA, SCL, CS#, D/C#, RES#, BS1, M/S#, CL	-	0.8V _{DDIO}	-	-	V
V _{IL}	Low level input voltage		-	-	-	0.2V _{DDIO}	V
V _{OH}	High level output voltage	SDA, BUSY, CL	I _{OH} = -100uA	0.9V _{DDIO}	-	-	V
V _{OL}	Low level output voltage		I _{OL} = 100uA	-	-	0.1V _{DDIO}	V
V _{PP}	OTP Program voltage	V _{PP}	-	7.25	7.5	7.75	V

Symbol	Parameter	Applicable pin	Test Condition	Min.	Typ.	Max.	Unit
Islp_VCI	Sleep mode current	VCI	- DC/DC off - No clock - No output load - MCU interface access - RAM data access	-	20	35	uA
Idslp_VCI1	Current of deep sleep mode 1	VCI	- DC/DC off - No clock - No output load - No MCU interface access - Retain RAM data but cannot access the RAM	-	1	3	uA
Idslp_VCI2	Current of deep sleep mode 2	VCI	- DC/DC off - No clock - No output load - No MCU interface access - Cannot retain RAM data	-	0.7	3	uA
lopr_VCI	Operating Mode current	VCI	VCI=3.0V	-	1000	-	uA
V _{GH}	Operating Mode Output Voltage	V _{GH}	Enable Clock and Analog by Master Activation Command V _{GH} =20V V _{GL} =-V _{GH} V _{SH1} =15V V _{SH2} =5V V _{SL} =-15V V _{COM} = -2V No waveform transitions. No loading. No RAM read/write No OTP read /write	19.5	20	20.5	V
V _{SH1}		V _{SH1}		14.8	15	15.2	V
V _{SH2}		V _{SH2}		4.9	5	5.1	V
V _{SL}		V _{SL}		-15.2	-15	-14.8	V
V _{COM}		V _{COM}		-2.2	-2	-1.8	V

Table 11-2: Regulators Characteristics

Symbol	Parameter	Test Condition	Applicable pin	Min.	Typ.	Max.	Unit
IVSH	VSH1 current	VSH1 = +15V	VSH1	-	-	800	uA
IVSH1	VSH2 current	VSH2 = +5V	VSH2	-	-	800	uA
IVSL	VSL current	VSL = -15V	VSL	-	-	800	uA
IVCOM	VCOM current	VCOM = -2V	VCOM	-	-	100	uA

12 AC Characteristics

12.1 Serial Peripheral Interface

The following specifications apply for: VDDIO - VSS = 2.2V to 3.7V, T_{OPR} = 25°C, CL=20pF

Table 12-1 : Serial Peripheral Interface Timing Characteristics

Write mode

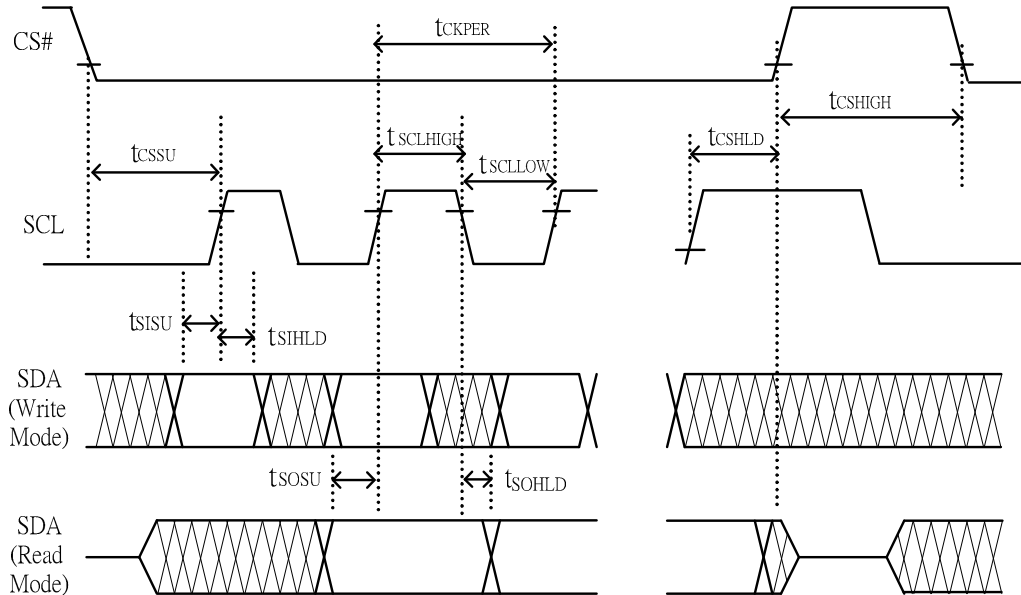
Symbol	Parameter	Min	Typ	Max	Unit
f _{SCL}	SCL frequency (Write Mode)	-	-	20	MHz
t _{CSSU}	Time CS# has to be low before the first rising edge of SCLK	60	-	-	ns
t _{CSHLD}	Time CS# has to remain low after the last falling edge of SCLK	65	-	-	ns
t _{CSHIGH}	Time CS# has to remain high between two transfers	100	-	-	ns
t _{SCLHIGH}	Part of the clock period where SCL has to remain high	25	-	-	ns
t _{SCLLOW}	Part of the clock period where SCL has to remain low	25	-	-	ns
t _{SISU}	Time SI (SDA Write Mode) has to be stable before the next rising edge of SCL	10	-	-	ns
t _{SIHLD}	Time SI (SDA Write Mode) has to remain stable after the rising edge of SCL	40	-	-	ns

Read mode

Symbol	Parameter	Min	Typ	Max	Unit
f _{SCL}	SCL frequency (Read Mode)	-	-	2.5	MHz
t _{CSSU}	Time CS# has to be low before the first rising edge of SCLK	100	-	-	ns
t _{CSHLD}	Time CS# has to remain low after the last falling edge of SCLK	50	-	-	ns
t _{CSHIGH}	Time CS# has to remain high between two transfers	250	-	-	ns
t _{SCLHIGH}	Part of the clock period where SCL has to remain high	180	-	-	ns
t _{SCLLOW}	Part of the clock period where SCL has to remain low	180	-	-	ns
t _{SOSU}	Time SO(SDA Read Mode) will be stable before the next rising edge of SCL	-	50	-	ns
t _{SOHLD}	Time SO (SDA Read Mode) will remain stable after the falling edge of SCL	-	0	-	ns

Note: All timings are based on 20% to 80% of VDDIO-VSS

Figure 12-1: SPI timing diagram



13 Application Circuit

Figure 13-1: Schematic of SSD1680A application circuit

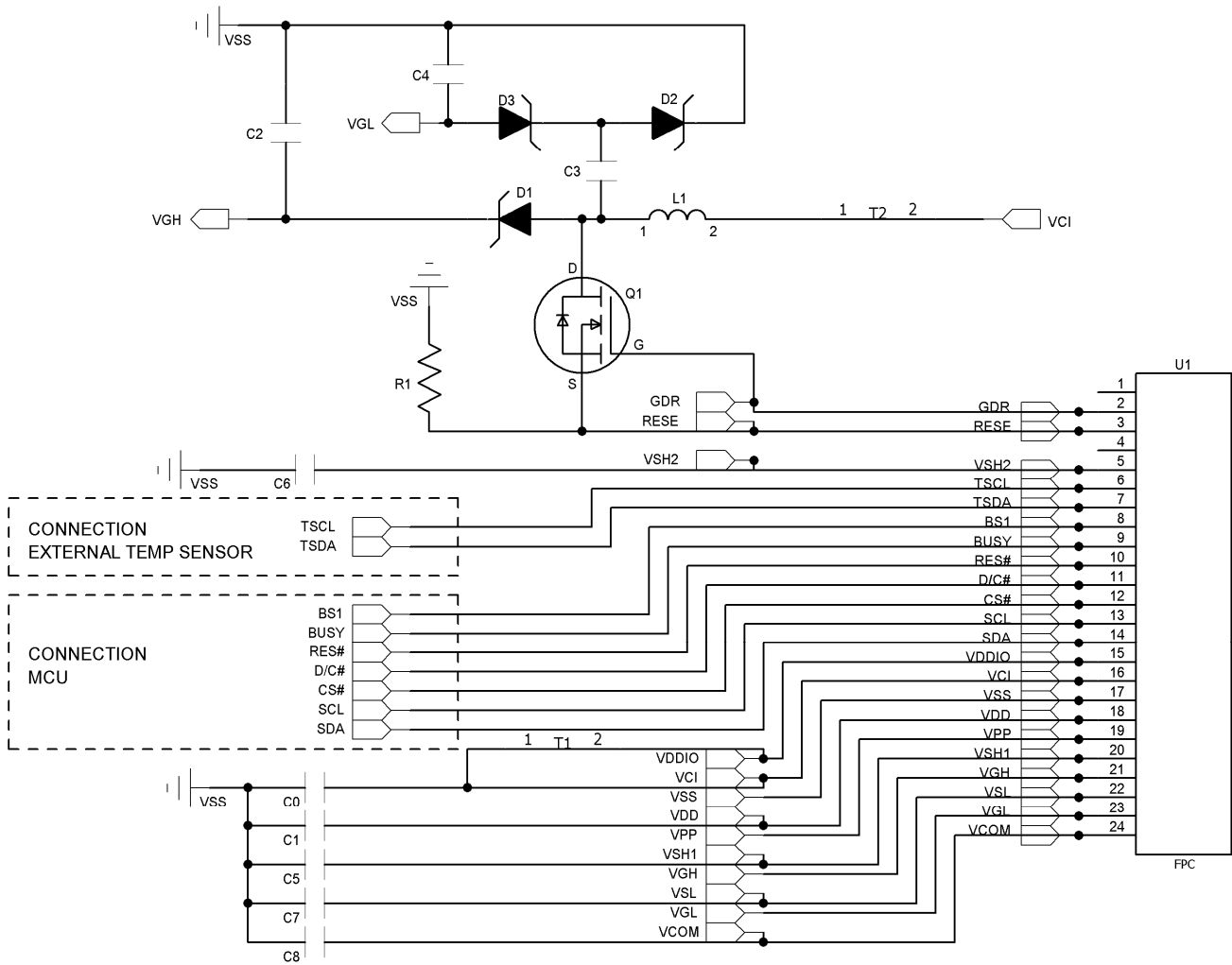


Table 13-1: Component list for SSD1680A application circuit

Part Name	Value	Requirements/Reference Part
C0-C1	1uF	X5R/X7R; Voltage Rating : 6V or 25V
C2-C7	1uF	0402/0603/0805; X5R/X7R; Voltage Rating : 25V
C8	0.47uF, 1uF	0402/0603/0805; X7R; Voltage Rating : 25V
R1	2.2 ohm	0402/0603/0805; 1% variation, ≥ 0.05W
D1-D3	Diode	MBR0530 1) Reverse DC voltage ≥ 30V 2) I _o ≥ 500mA 3) Forward voltage ≤ 430mV
Q1	NMOS	Si1304BDL/NX3008NBK 1) Drain-Source breakdown voltage ≥ 30V 2) V _{gs(th)} = 0.9V (Typ), 1.3V (Max) 3) R _{ds on} ≤ 2.1Ω @ V _{gs} = 2.5V
L1	47uH	CDRH2D18 / LDNP-470NC I _o = 500mA (Max)
U1	0.5mm ZIF socket	24pins, 0.5mm pitch

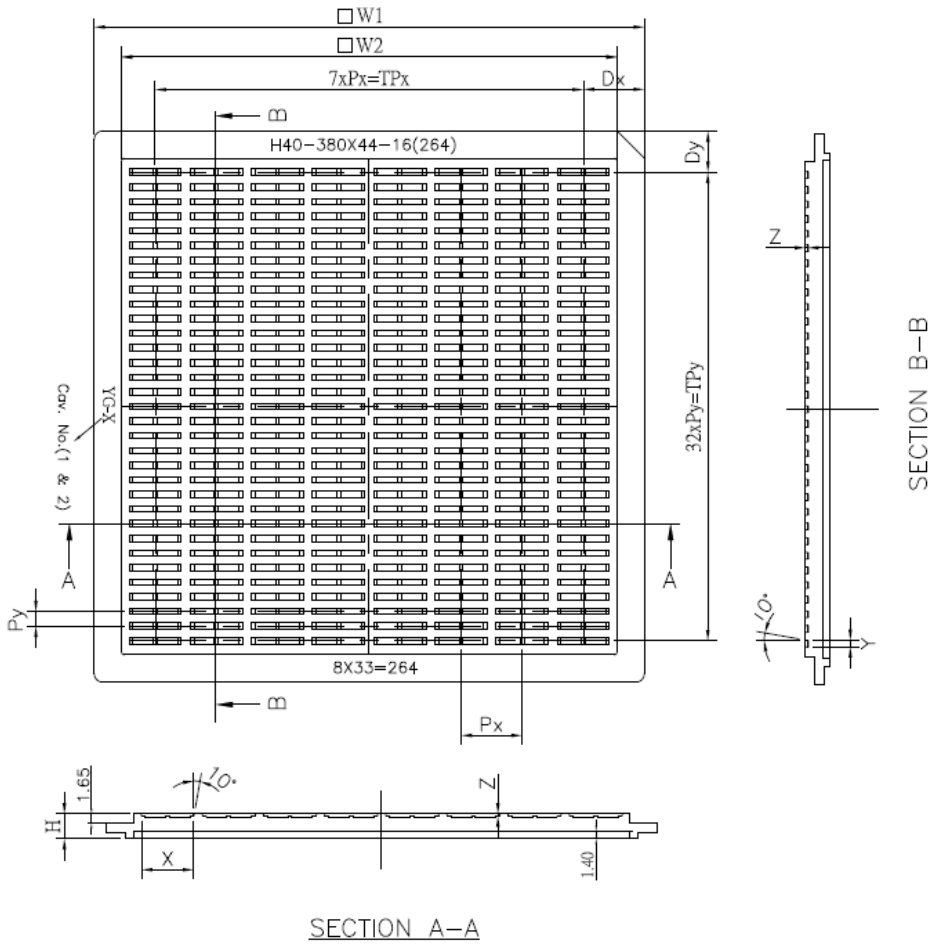
Remarks:

- 1) The recommended component value and reference part in Table 14-1 is subject to change depending on panel loading.
- 2) Customer is required to review if the selected component value and part is suitable for their application.

14 Package Information

14.1 Die Tray Dimensions for SSD1680AZ

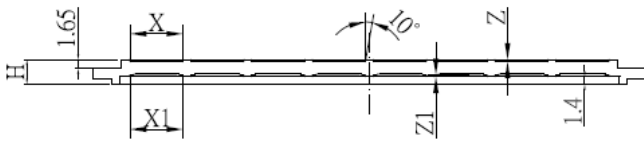
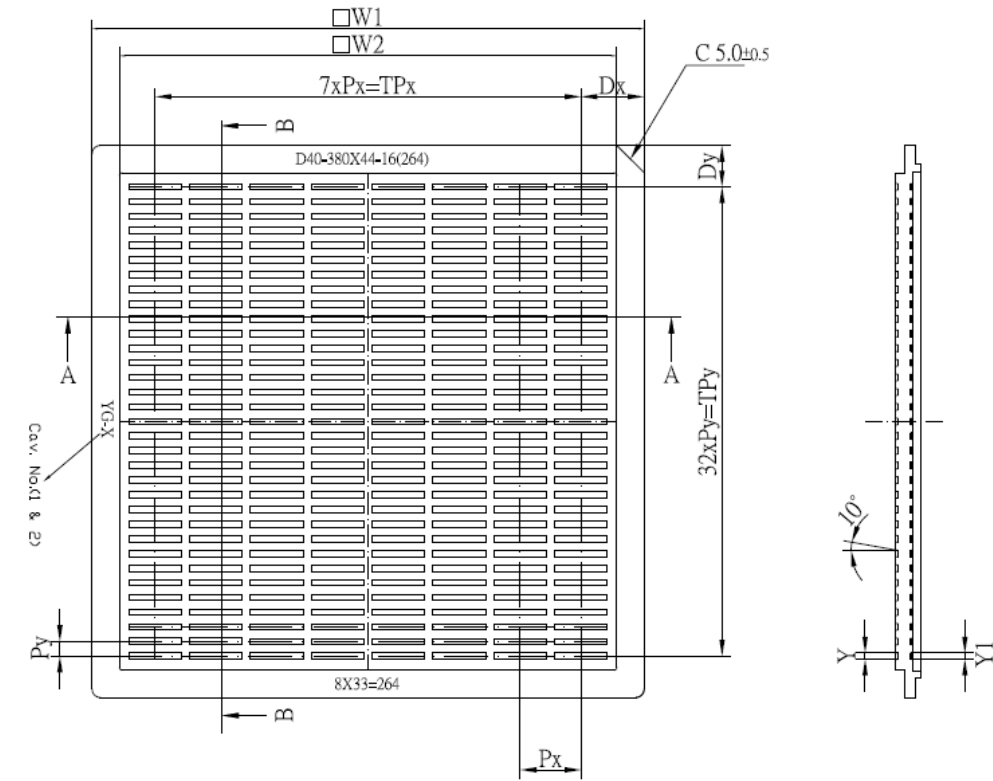
Figure 14-1 : SSD1680AZ die tray information (unit: mm)



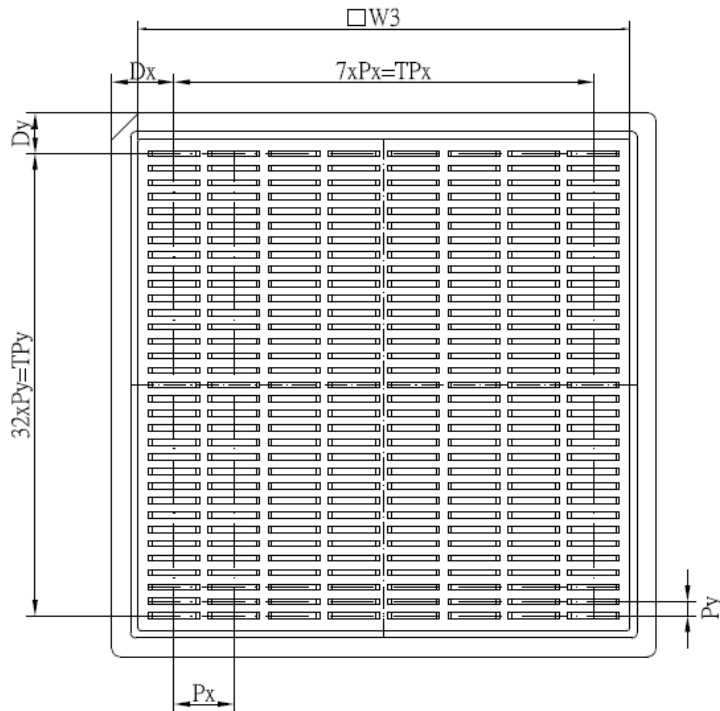
Symbol	Spec(mm)
W1	101.60±0.10
W2	91.55±0.10
W3	91.85±0.10
H	4.55±0.10
Dx	11.25±0.10
TPx	79.10±0.10
Dy	7.60±0.10
TPy	86.40±0.10
Px	11.30±0.05
Py	2.70±0.05
X	9.661±0.05
Y	1.125±0.05
Z	0.40±0.05
N	264(pocket number)

14.2 Die Tray Dimensions for SSD1680AZ8

Figure 14-2 : SSD1680AZ8 die tray information (unit: mm)




SECTION A-A



Symbol	Spec (mm)
W1	101.60±0.10
W2	91.55±0.10
W3	91.75±0.10
H	4.55±0.10
Px	11.20±0.05
Py	2.70±0.05
Dx	11.60±0.05
TPx	78.40±0.10
Dy	7.60±0.05
TPy	86.40±0.10
X	9.661±0.05
Y	1.125±0.05
Z	0.40±0.05
X1	9.661±0.05
Y1	1.125±0.05
Z1	0.35±0.05
N	8x33=264 (pocket number)

Solomon Systech reserves the right to make changes without notice to any products herein. Solomon Systech makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Solomon Systech assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any, and all, liability, including without limitation consequential or incidental damages. "Typical" parameters can and do vary in different applications. All operating parameters, including "Typical" must be validated for each customer application by the customer's technical experts. Solomon Systech does not convey any license under its patent rights nor the rights of others. Solomon Systech products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Solomon Systech product could create a situation where personal injury or death may occur. Should Buyer purchase or use Solomon Systech products for any such unintended or unauthorized application, Buyer shall indemnify and hold Solomon Systech and its offices, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Solomon Systech was negligent regarding the design or manufacture of the part.

 The product(s) listed in this datasheet comply with Directive 2011/65/EU of the European Parliament and of the council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment and People's Republic of China Electronic Industry Standard GB/T 26572-2011 "Requirements for concentration limits for certain hazardous substances in electronic information products (电子电器产品中限用物质的限用要求)". Hazardous Substances test report is available upon request.

<http://www.solomon-systech.com>